



AO4427

P-Channel Enhancement Mode Field Effect Transistor

General Description

The AO4427/L uses advanced trench technology to provide excellent $R_{DS(ON)}$, and ultra-low low gate charge with a 25V gate rating. This device is suitable for use as a load switch or in PWM applications. The device is ESD protected.

AO4427 and AO4427L are electrically identical.

- -RoHS Compliant
- -AO4427L is Halogen Free

Features

 $V_{DS}(V) = -30V$

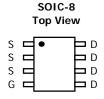
 $I_D = -12.5 \text{ A } (V_{GS} = -20 \text{V})$

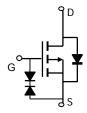
 $R_{DS(ON)}$ < 12m Ω (V_{GS} = -20V)

 $R_{DS(ON)}$ < 14m Ω (V_{GS} = -10V)

ESD Rating: 2KV HBM

Ciss, Coss, Crss Tested





Absolute Maximum Ratings T _A =25°C unless otherwise noted								
Parameter		Symbol	Maximum	Units				
Drain-Source Voltage		V_{DS}	-30	V				
Gate-Source Voltage		V_{GS}	±25	V				
Continuous Drain	T _A =25°C		-12.5					
Current AF	T _A =70°C	I _D	-10.5	A				
Pulsed Drain Current ^B		I _{DM}	-60					
	T _A =25°C	D	3	10/				
Power Dissipation A	T _A =70°C	$-P_D$	2.1	- W				
Junction and Storage Temperature Range		T _J , T _{STG}	-55 to 150	°C				

Thermal Characteristics									
Parameter	Symbol	Тур	Max	Units					
Maximum Junction-to-Ambient AF	t ≤ 10s	$ R_{\theta JA}$	28	40	°C/W				
Maximum Junction-to-Ambient A	Steady-State	ady-State		75	°C/W				
Maximum Junction-to-Lead ^C	Steady-State	$R_{\theta JL}$	21	30	°C/W				

Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter Conditions		Min	Тур	Max	Units
STATIC F	PARAMETERS					
BV _{DSS}	Drain-Source Breakdown Voltage	$I_D = -250 \mu A, V_{GS} = 0 V$	-30			V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =-30V, V _{GS} =0V			-1	μА
		T _J =55°C			-5	μΑ
I _{GSS}	Gate-Body leakage current	V _{DS} =0V, V _{GS} =±25V			±10	μА
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}$ $I_{D}=-250\mu A$	-1.7	-2.5	-3	V
$I_{D(ON)}$	On state drain current	V _{GS} =-10V, V _{DS} =-5V	-60			Α
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =-20V, I _D =-12.5A		9.4	12	mΩ
		T _J =125°C		12.2	15	11122
		V _{GS} =-10V, I _D =-10A		11.5	14	mΩ
		V_{GS} =-4.5V, I_D =-5A		32		mΩ
g FS	Forward Transconductance	V_{DS} =-5V, I_{D} =-12.5A		24		S
V_{SD}	Diode Forward Voltage	I _S =-1A,V _{GS} =0V			-1	V
I _S	Maximum Body-Diode Continuous Curr			-4.2	Α	
DYNAMIC	PARAMETERS					
C _{iss}	Input Capacitance			2330	2900	pF
Coss	Output Capacitance	V_{GS} =0V, V_{DS} =-15V, f=1MHz		480		pF
C_{rss}	Reverse Transfer Capacitance			320	448	pF
R_g	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1MHz	3.4	6.8	10	Ω
SWITCHI	NG PARAMETERS					
Q_g	Total Gate Charge	V _{GS} =-10V, V _{DS} =-15V,		41	52	nC
Q_{gs}	Gate Source Charge	I _D =-12.5A		10		nC
Q_{gd}	Gate Drain Charge	15 12.07		12		nC
t _{D(on)}	Turn-On DelayTime			12.8		ns
t _r	Turn-On Rise Time	V_{GS} =-10V, V_{DS} =-15V, R_L =1.2 Ω ,		10.3		ns
t _{D(off)}	Turn-Off DelayTime	R_{GEN} =3 Ω		49.5		ns
t _f	Turn-Off Fall Time			29		ns
t _{rr}	Body Diode Reverse Recovery Time	I _F =-12.5A, dI/dt=100A/μs		28	35	ns
Q _{rr}	Body Diode Reverse Recovery Charge I _F =-12.5A, dI/dt=100A/µs			20		nC

A: The value of R_{BJA} is measured with the device mounted on 1in 2 FR-4 board with 2oz. Copper, in a still air environment with

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T $_{\rm A}$ =25°C. The value in any given application depends on the user's specific board design.

B: Repetitive rating, pulse width limited by junction temperature.

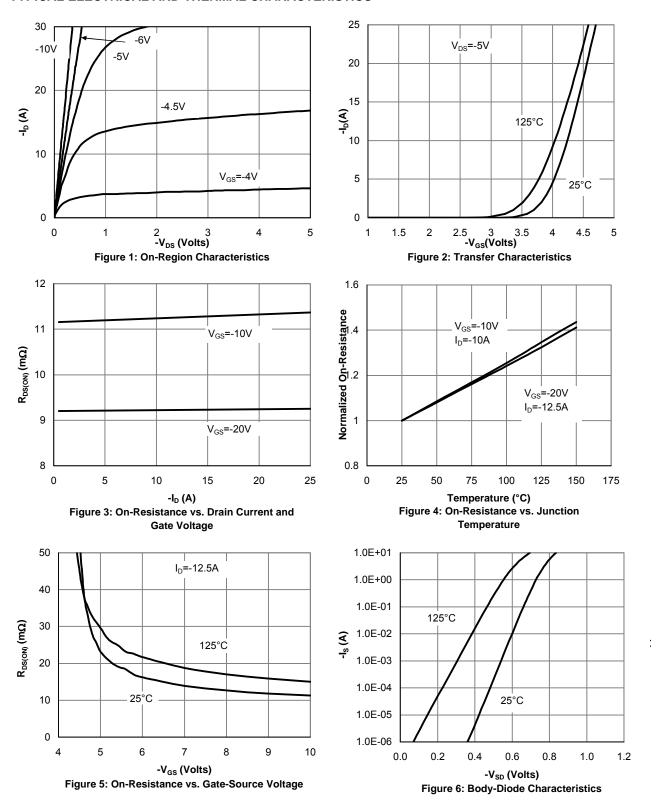
C. The $R_{\theta JA}$ is the sum of the thermal impedence from junction to lead $R_{\theta JL}$ and lead to ambient.

D. The static characteristics in Figures 1 to 6 are obtained using <300 μs pulses, duty cycle 0.5% max.

E. These tests are performed with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with T_k=25°C. The SOA curve provides a single pulse rating.

F. The current rating is based on the ≤ 10s junction to ambient thermal resistance rating.

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS



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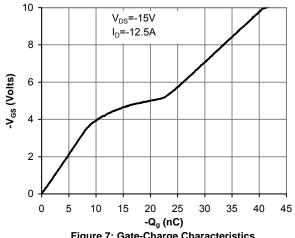


Figure 7: Gate-Charge Characteristics

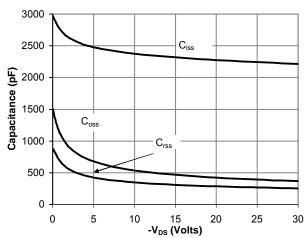
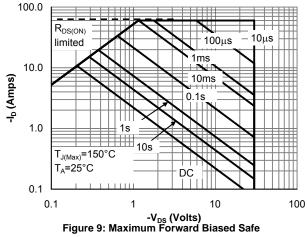


Figure 8: Capacitance Characteristics



Operating Area (Note E)

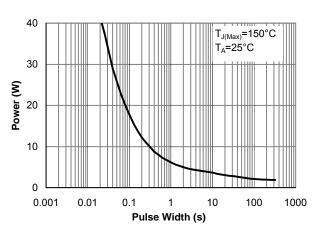


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

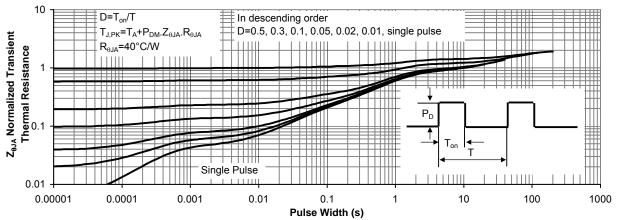


Figure 11: Normalized Maximum Transient Thermal Impedance